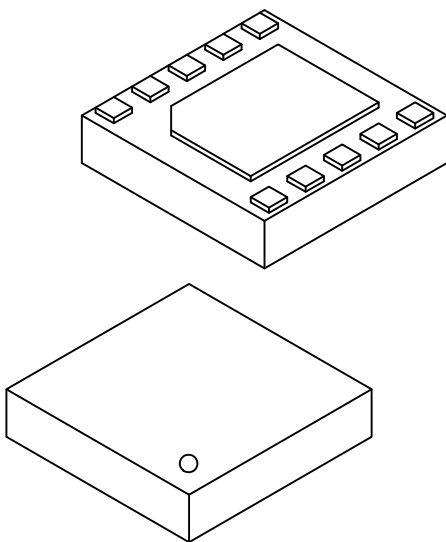


# 10-Lead Ultra Thin Plastic Dual Flat, No Lead Package (3VW) - 2x2x0.55 mm Body [UDFN] Saw Singulated with Pullback Leads

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



		Units	MILLIMETERS		
Dimension Limits			MIN	NOM	MAX
Number of Terminals	N		10		
Pitch	e		0.40 BSC		
Overall Height	A	0.45	0.50	0.55	
Standoff	A1	0.00	–	0.05	
Overall Length	D		2.00 BSC		
Exposed Pad Length	D2	1.35	1.40	1.45	
Overall Width	E		2.00 BSC		
Exposed Pad Width	E2	1.05	1.10	1.15	
Terminal Width	b	0.15	0.20	0.25	
Terminal Length	L	0.15	0.20	0.25	
Terminal Pullback	L1		0.05 REF		
Terminal-to-Exposed-Pad	K		0.20 REF		

**Notes:**

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- Package is saw singulated
- Dimensioning and tolerancing per ASME Y14.5M  
 BSC: Basic Dimension. Theoretically exact value shown without tolerances.  
 REF: Reference Dimension, usually without tolerance, for information purposes only.